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(12) United States Patent Chen

(54) GROUNDING STRUCTURE AND GROUNDING METHOD OF VACUUM TUBE AUDIO AMPLIFIER

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(58) Field of Classification Search

None

See application file for complete search history.

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(57) ABSTRACT

The invention provides a grounding structure and a grounding method for a vacuum tube audio amplifier, the grounding structure and the grounding method including: with respect to a power source, utilizing a power circuit without a choke, an anti-coupling circuit, and a filament voltage regulator circuit; and with respect to the grounding method, utilizing an negative output terminal of an audio output transforming circuit or a negative terminal of a filter capacitor in the power circuit as a single ground terminal of the vacuum tube audio amplifier, and not arranging a grounding metal bottom plate therein, in order to achieve a compact, lightweight desktop model of a vacuum tube audio amplifier.

14 Claims, 10 Drawing Sheets

